

#### **Selection Guide**

		7C274-30	7C271-35 7C274-35	7C271-45 7C274-45	7C271-55	Unit
Maximum Access Time		30	35	45	55	ns
Maximum Operating	Com'l	120	120	120	120	mA
Current	Military		130	130	130	mA
Standby Current	Com'l	30	30	30	30	mA
	Military		40	40	40	mA

#### Maximum Ratings[1]

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature ......-65°C to +150°C Ambient Temperature with Power Applied.....-55°C to +125°C

Supply Voltage to Ground Potential .....-0.5V to +7.0V DC Voltage Applied to Outputs in High Z State ......-0.5V to +7.0V DC Input Voltage .....-3.0V to +7.0V

DC Program Voltage ......13.0V

Static Discharge Voltage.....>2001V (per MIL-STD-883, Method 3015) Latch-Up Current.....>200 mA UV Exposure ......7258 Wsec/cm<sup>2</sup>

### **Operating Range**

Range	Ambient Temperature	v <sub>cc</sub>
Commercial	0°C to +70°C	5V ±10%
Military <sup>[2]</sup>	−55°C to +125°C	5V ±10%

### Electrical Characteristics Over the Operating Range<sup>[3]</sup>

				7C271- 3 7C274-3	55, 45, 55 0, 35, 45,	
Parameter	Description	Test Condition	ns	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -2.0 \text{ mA}$		2.4		V
V <sub>OL</sub>	Output LOW Voltage	$V_{CC} = Min., I_{OL} = 8.0 \text{ mA}^{[4]}$			0.4	V
V <sub>IH</sub>	Input HIGH Level	Guaranteed Input Logical HIG Inputs	Guaranteed Input Logical HIGH Voltage for All Inputs		V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Level	Guaranteed Input Logical LOW Voltage for All Inputs			0.8	V
I <sub>IX</sub>	Input Current	$GND \le V_{IN} \le V_{CC}$		-10	+10	μΑ
I <sub>OZ</sub>	Output Leakage Current	$GND \le V_{OUT} \le V_{CC}$ , Output I	Disabled	-40	+40	μΑ
I <sub>OS</sub>	Output Short Circuit Current <sup>[5]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = GND		-20	-90	mA
I <sub>CC</sub>	Power Supply Current	$V_{CC} = Max., V_{IN} = 2.0V,$	Commercial		120	mA
		I <sub>OUT</sub> = 0 mA, ČË=V <sub>IL</sub>	Military		130	1
I <sub>SB</sub>	Standby Supply Current	$V_{CC} = Max., \overline{CE} = V_{IH},$	Commercial		30	mA
		I <sub>OUT</sub> = 0 mA	Military		40	1
V <sub>PP</sub>	Programming Supply Voltage		•	12	13	V
I <sub>PP</sub>	Programming Supply Current				50	mA

#### Notes

- 1. The voltage on any input or I/O pin cannot exceed the power pin during power-up.
- T<sub>A</sub> is the "instant on" case temperature.

  See the last page of this specification for Group A subgroup testing information.
- 5. For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.

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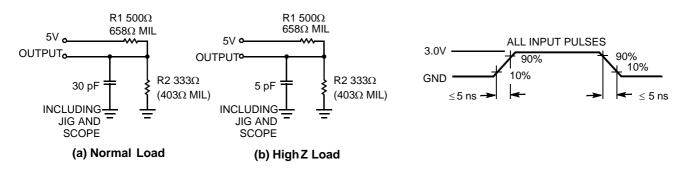
## Electrical Characteristics Over the Operating Range<sup>[3]</sup>

			7C271- 35, 45, 55 7C274-30, 35, 45,		
Parameter	Description	Test Conditions	Min.	Max.	Unit
V <sub>IHP</sub>	Input HIGH Programming Voltage		3.0		V
V <sub>ILP</sub>	Input LOW Programming Voltage			0.4	V

# Capacitance<sup>[6]</sup>

Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	10	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 5.0V$	10	pF

#### AC Test Loads and Waveforms<sup>[6]</sup>



Equivalent to: THÉVENIN EQUIVALENT

 $200\Omega$  $250\Omega$ OUTPUT . → 2.00V COMMERCIAL OUTPUT -1.90V MILITARY

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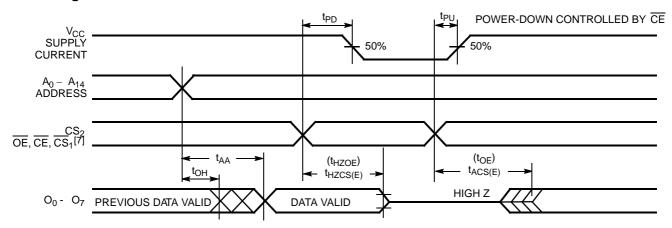
<sup>6.</sup> See Introduction to CMOS PROMs for general information on testing.



# Switching Characteristics Over the Operating Range<sup>[3,6]</sup>

		7C274-30		7C274-30 7C271-35 7C274-35		7C271-45 7C274-45		7C271-55		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>AA</sub>	Address to Output Valid		30		35		45		55	ns
t <sub>HZCS</sub>	Chip Select Inactive to High Z (CS <sub>1</sub> and CS <sub>2</sub> , 7C271 Only)		20		25		30		30	ns
t <sub>ACS</sub>	Chip Select Active to Output Valid ( $\overline{\text{CS}}_1$ and $\overline{\text{CS}}_2$ , 7C271 Only)		20		25		30		30	ns
t <sub>HZOE</sub>	Output Enable Inactive to High Z (OE, 7C274 Only)		20		20		25		25	ns
t <sub>OE</sub>	Output Enable Active to Output Valid (OE, 7C274 Only)		20		20		25		25	ns
t <sub>HZCE</sub>	Chip Enable Inactive to High Z (CE Only)		35		40		50		60	ns
t <sub>ACE</sub>	Chip Enable Active to Output Valid (CE Only)		35		40		50		60	ns
t <sub>PU</sub>	Chip Enable Active to Power Up	0		0		0		0		ns
t <sub>PD</sub>	Chip Enable Inactive to Power Down		35		40		50		60	ns
t <sub>OH</sub>	Output Hold from Address Change	0		0		0		0		ns

#### **Switching Waveform**



#### **Erasure Characteristics**

Wavelengths of light less than 4000 angstroms begin to erase the CY7C271 and CY7C274 in the windowed package. For this reason, an opaque label should be placed over the window if the PROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 angstroms for a minimum dose (UV intensity × exposure time) of 25 Wsec/cm<sup>2</sup>. For an ultraviolet lamp with a 12 mW/cm<sup>2</sup> power rating, the exposure time would be approximately 35 minutes. The CY7C271 or CY7C274 needs to be within 1 inch of the lamp during erasure. Permanent damage may result if the

PROM is exposed to high-intensity UV light for an extended period of time. 7258 Wsec/cm<sup>2</sup> is the recommended maximum dosage.

#### **Programming Modes**

Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

#### Note

7.  $CS_2$  and  $\overline{CS}_1$  are used on the 7C271 only.  $\overline{OE}$  is used on the 7C274 only.

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Table 1. CY7C271 Mode Selection

		Pin Function <sup>[8]</sup>				
	Read or Output Disable	A <sub>14</sub> -A <sub>0</sub>	CE	CS <sub>2</sub>	CS <sub>1</sub>	O <sub>7</sub> -O <sub>0</sub>
Mode	Other	A <sub>14</sub> -A <sub>0</sub>	VFY	PGM	V <sub>PP</sub>	D <sub>7</sub> D <sub>0</sub>
Read		A <sub>14</sub> -A <sub>0</sub>	V <sub>IL</sub>	V <sub>IH</sub>	V <sub>IL</sub>	O <sub>7</sub> -O <sub>0</sub>
Power Dow	n	A <sub>14</sub> -A <sub>0</sub>	V <sub>IH</sub>	Х	X	High Z
Output Disa	ıble	A <sub>14</sub> -A <sub>0</sub>	X	V <sub>IL</sub>	X	High Z
Output Disa	ıble	A <sub>14</sub> -A <sub>0</sub>	X	Х	V <sub>IH</sub>	High Z
Program		A <sub>14</sub> -A <sub>0</sub>	V <sub>IHP</sub>	V <sub>ILP</sub>	V <sub>PP</sub>	D <sub>7</sub> D <sub>0</sub>
Program Ve	erify	A <sub>14</sub> -A <sub>0</sub>	$V_{ILP}$	V <sub>IHP</sub> /V <sub>ILP</sub>	V <sub>PP</sub>	O <sub>7</sub> -O <sub>0</sub>
Program Inl	nibit	A <sub>14</sub> -A <sub>0</sub>	V <sub>IHP</sub>	V <sub>IHP</sub>	V <sub>PP</sub>	High Z
Blank Chec	k	A <sub>14</sub> –A <sub>0</sub>	$V_{ILP}$	V <sub>IHP</sub> /V <sub>ILP</sub>	V <sub>PP</sub>	O <sub>7</sub> -O <sub>0</sub>

Table 2. CY7C274 Mode Selection

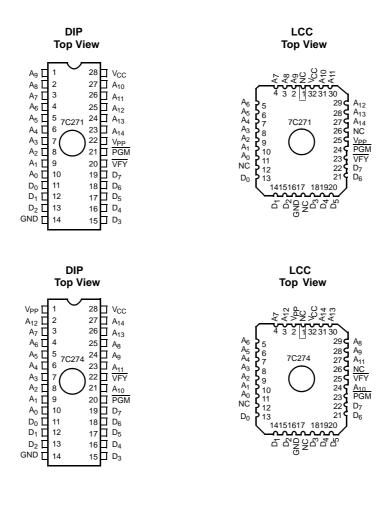
		Pin Function <sup>[8]</sup>				
	Read or Output Disable	A <sub>14</sub> -A <sub>0</sub>	OE	CE	V <sub>PP</sub>	O <sub>7</sub> -O <sub>0</sub>
Mode	Other	A <sub>14</sub> -A <sub>0</sub>	VFY	PGM	V <sub>PP</sub>	D <sub>7</sub> D <sub>0</sub>
Read		A <sub>14</sub> -A <sub>0</sub>	V <sub>IL</sub>	$V_{IL}$	Note 9	O <sub>7</sub> -O <sub>0</sub>
Output Disa	able	A <sub>14</sub> -A <sub>0</sub>	V <sub>IH</sub>	X	X	High Z
Power Dow	n	A <sub>14</sub> -A <sub>0</sub>	Х	V <sub>IH</sub>	X	High Z
Program		A <sub>14</sub> -A <sub>0</sub>	V <sub>IHP</sub>	$V_{\rm ILP}$	$V_{PP}$	D <sub>7</sub> -D <sub>0</sub>
Program Ve	erify	A <sub>14</sub> -A <sub>0</sub>	$V_{ILP}$	V <sub>IHP</sub> /V <sub>ILP</sub>	$V_{PP}$	O <sub>7</sub> -O <sub>0</sub>
Program Inl	hibit	A <sub>14</sub> -A <sub>0</sub>	V <sub>IHP</sub>	V <sub>IHP</sub>	$V_{PP}$	High Z
Blank Chec	k	A <sub>14</sub> -A <sub>0</sub>	$V_{ILP}$	V <sub>IHP</sub> /V <sub>ILP</sub>	$V_{PP}$	O <sub>7</sub> -O <sub>0</sub>

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 $<sup>\</sup>begin{array}{ll} \textbf{Notes} \\ 8. & \textbf{X} \text{ can be V}_{\text{IL}} \left( \textbf{V}_{\text{ILP}} \right) \text{ or V}_{\text{IH}} \left( \textbf{V}_{\text{IHP}} \right). \\ 9. & \textbf{V}_{PP} \text{ should be tied to V}_{CC} \pm 5\% \text{ in read mode.} \end{array}$ 



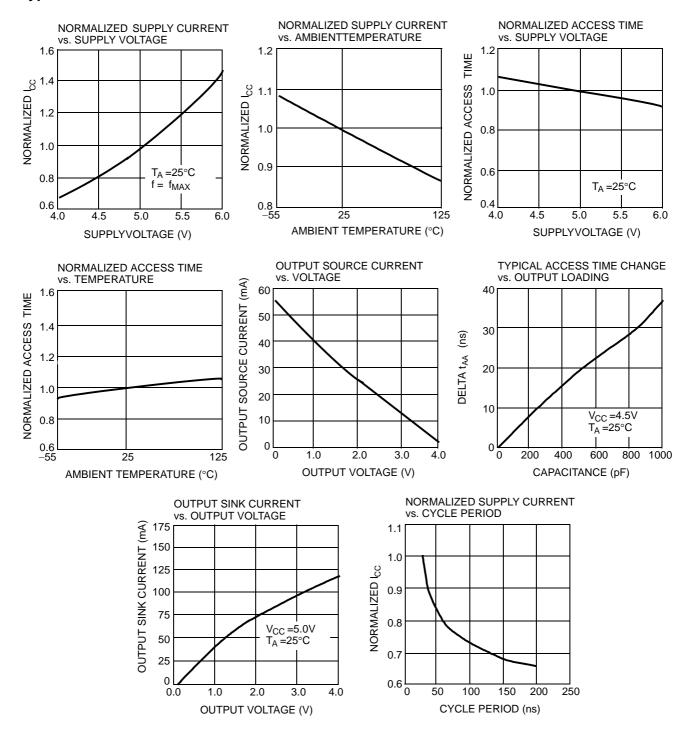
**Figure 1. Programming Pinouts** 



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## **Typical DC and AC Characteristics**



C271-14

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# **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
35	CY7C271-35WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military
45	CY7C271-45WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military
	CY7C274-45WMB	W16	28-Lead (600-Mil) Windowed CerDIP	]
55	CY7C271-55WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military

## **MILITARY SPECIFICATIONS Group A Subgroup Testing**

#### **DC Characteristics**

Parameter	Subgroups
V <sub>OH</sub>	1, 2, 3
V <sub>OL</sub>	1, 2, 3
V <sub>IH</sub>	1, 2, 3
V <sub>IL</sub>	1, 2, 3
I <sub>IX</sub>	1, 2, 3
I <sub>OZ</sub>	1, 2, 3
I <sub>CC</sub>	1, 2, 3
I <sub>SB</sub>	1, 2, 3

# **Switching Characteristics**

Parameter	Subgroups
t <sub>AA</sub>	7, 8, 9, 10, 11
t <sub>ACS</sub> <sup>[10]</sup>	7, 8, 9, 10, 11
t <sub>OE</sub> <sup>[11]</sup>	7, 8, 9, 10, 11
t <sub>ACE</sub>	7, 8, 9, 10, 11

#### **SMD Cross Reference**

SMD Number	Suffix	Cypress Number
5962-89817	01ZX	CY7C271-55QMB
5962-89817	02XX	CY7C271-45WMB
5962-89817	02ZX	CY7C271-45QMB

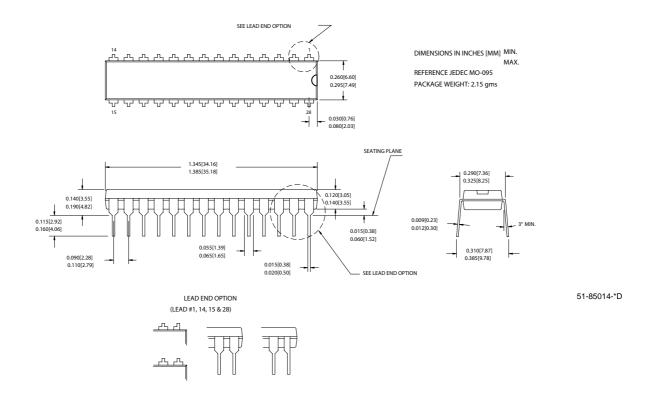
Notes 10. 7C271 only ( $\overline{\text{CS}}_1$  and  $\text{CS}_2$ ). 11. 7C274 only.

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### **Package Diagrams**

#### Figure 2. 28-Lead (300-Mil) PDIP P21



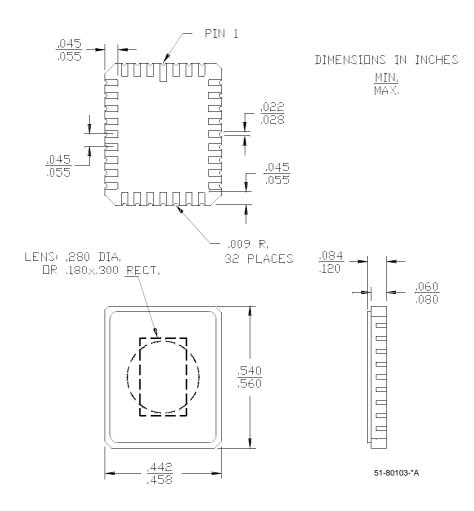
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#### Package Diagrams (continued)

#### Figure 3. 32-Pin Windowed Rectangular Leadless Chip Carrier Q55

#### MIL-STD-1835 C-12



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# Package Diagrams (continued)

#### Figure 4. 28-Lead (600-Mil) Windowed CerDIP W16

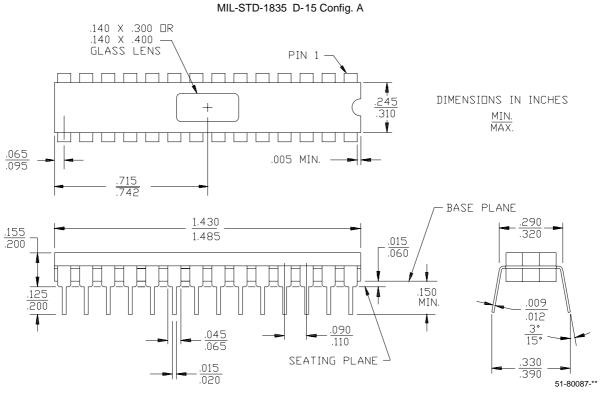
# MIL-STD-1835 D-10 Config. A .300 DIA DR .350 DIA LENS PIN 1 DIMENSIONS IN INCHES MIN. MAX. ,505 ,550 .005 MIN. — BASE PLANE .590 .620 1.430 <u>.175</u> .225 1.490 .015 .060 .009 ,150 MIN. .090 SEATING PLANE 51-80020-\*\*

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#### Package Diagrams (continued)

#### Figure 5. 28-Lead (300-Mil) Windowed CerDIP W22



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# **Document History Page**

Document Title: CY7C271 CY7C274 32K x 8 Power Switched and Reprogrammable PROM Document Number: 38-04008				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	113864	3/8/02	DSG	Changed from Spec number: 38-00068 to 38-04008
A*	118899	10/10/02	GBI	Updated Ordering Information
*B	122249	12/27/02	RBI	Added power up requirements to Operating Conditions information
*C	499542	See ECN	PCI	Updated Ordering Information

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